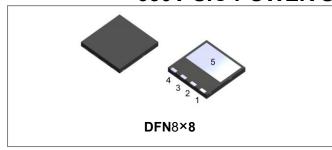






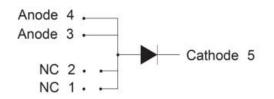
S3D06065L 650V SIC POWER SCHOTTKY RECTIFIER



Description

S3D06065L is a SiC Schottky rectifier packaged in DFN8×8 case. The device is a high voltage Schottky rectifier that has very low total conduction losses and very stable switching characteristics over temperature extremes. The S3D06065L is ideal for energy sensitive, high frequency applications in challenging environments.

Circuit Diagram



Applications

- Alternative energy inverters
- Power Factor Correction (PFC)
- Free-Wheeling diodes
- Switching supply output rectification
- Reverse polarity protection

Features

- 175°C T_J operation
- Ultra-low switching loss
- Switching speeds independent of operating temperature
- Low total conduction losses
- · High forward surge current capability
- High package isolation voltage
- Terminals finish: 100% Pure Tin
- "-A" is an AEC-Q101 qualified device
- Pb Free Device
- All SMC parts are traceable to the wafer lot
- Additional electrical and life testing can be performed upon request

Maximum Ratings

Characteristics	Symbol	Condition	Max.	Units
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V _{RRM} V _{RWM} V _{DC}	-	650	V
	I _{F (AV)1}	Tc=25°C	24	Α
Average Rectified Forward Current	I _{F (AV)2}	Tc=136°C	9	Α
	I _{F (AV)3}	Tc=157°C	6	Α
	I _{FRM1}	10ms, Half Sine pulse, T _J =25°C	30	Α
Repetitive Peak Forward Surge Current	I _{FRM2}	10ms, Half Sine pulse, T _J =110°C	20	Α
	I _{FSM1}	10ms, Half Sine pulse, T _J =25°C	70	Α
Peak One Cycle Non-Repetitive Surge Current	I _{FSM2}	10ms, Half Sine pulse, T _J =110°C	48	Α
Non-Repetitive Peak Forward Surge Current	I _{F,Max}	10µs. Pulse, T₃=25°C	600	Α
Non-Nepetitive Feak Forward Surge Current	I _{F,Max}	10µs. Pulse, T₃=110°C	500	Α
Davis Diagination	P _{tot1}	T _J =25°C	103	W
Power Dissipation	P _{tot1}	T _J =110°C	45	W

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Electrical Characteristics:

Characteristics	Symbol	Condition	Тур.	Max.	Units
Forward Voltage Drop*	V_{F1}	@ 6A, Pulse, T _J = 25 °C	1.5	1.7	V
Transfer and the second	V_{F2}	@ 6A, Pulse, T _J = 175 °C	1.9	2.4	V
Reverse Current*	I _{R1}	$@V_R = \text{rated } V_R$ $T_J = 25 ^{\circ}\text{C}$	0.03	3	uA
	I _{R2}	$@V_R = \text{rated } V_R$ $T_J = 175 ^{\circ}\text{C}$	0.6	25	uA
Junction Capacitance	Ст	V _R =0V, T _J =25℃, f=1MHz	382	-	pF
Reverse Recovery Charge	Qc	I _F = 6A, di/dt = 200A/µs VR = 400 V, T _J =25°C	23.8	-	nC
Capacitance Stored Energy	E c	V _R = 400 V	5.88	-	μJ

^{*} Pulse width < 300 µs, duty cycle < 2%

Thermal-Mechanical Specifications:

Characteristics	Symbol	Condition	Specification	Units
Junction Temperature	TJ	-	-55 to +175	°C
Storage Temperature	T _{stg}	-	-55 to +175	°C
Typical Thermal Resistance Junction to Case	R _θ Jc	DC operation	2.5	°C/W

Marking Diagram



Where XXXXX is YYWWL

S3D = Device Type L = Package type 06 = Forward Current (6A) 065 = Reverse Voltage (650V)

 SSG
 = SSG

 YY
 = Year

 WW
 = Week

 L
 = Lot Number

Cautions: Molding resin

Epoxy resin UL:94V-0

Ordering Information

Device	Package	Shipping
S3D06065L	DFN 8×8	3000/Reel
S3D06065LTR	DFN 8×8	3000/Reel

For information on tape and reel specifications, including part orientation and tape sizes, please refer to our tape and reel packaging specification.

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Ratings and Characteristics Curves

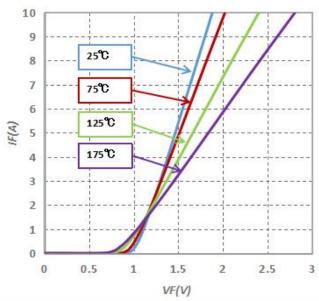


Fig.1-Typical Forward Voltage Characteristics

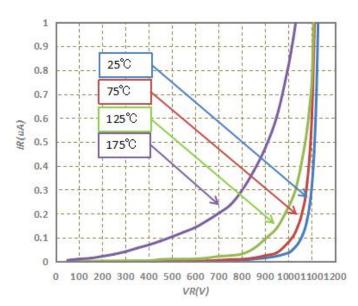


Fig.2-Typical Reverse Characteristics

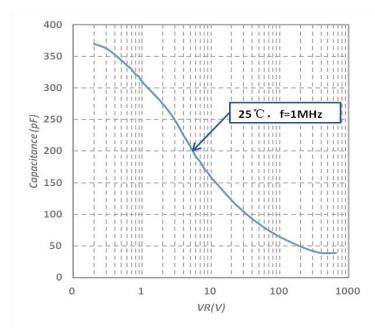


Fig.3-Capacitance vs. Reverse Voltage

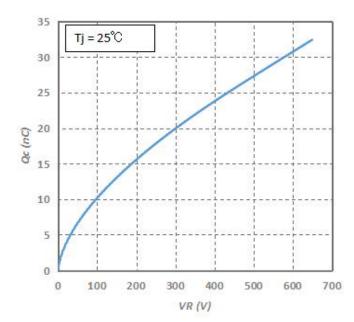


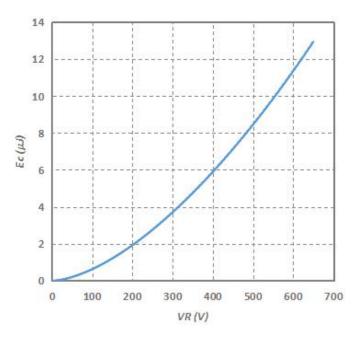
Fig.4-Total Capacitance Charge vs. Reverse Voltage

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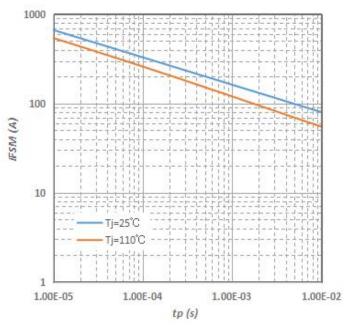
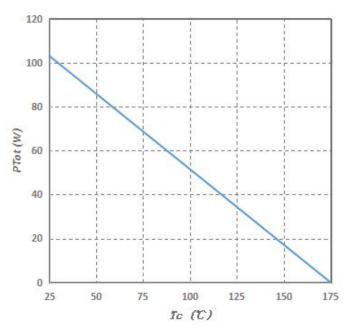


Fig.5-Capacitance Stored Energy

Fig.6-Non-repetitive peak forward surge current versus pulse duration (sinusoidal waveform)



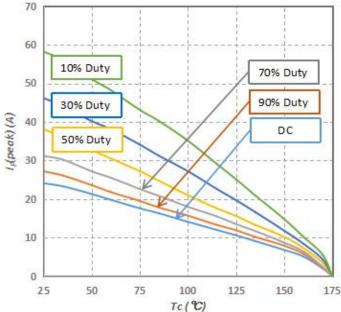


Fig.7-Power Derating

Fig.8-Current Derating

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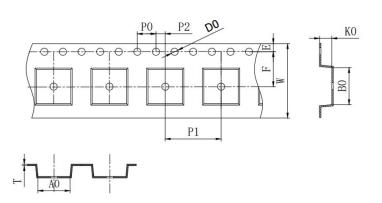
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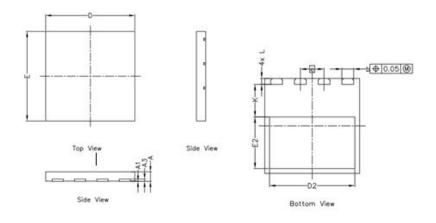


Carrier Tape & Reel Specification DFN8×8



SYMBOL	Millimeters		
STWIBOL	Min.	Max.	
A0	8.30	8.50	
В0	8.40	8.60	
K0	1.20	1.40	
P0	3.90	4.10	
P1	11.90	12.10	
P2	1.95	2.05	
Т	0.20	0.30	
E	1.65	1.85	
F	7.40	7.60	
D0	1.50	1.60	
D1	1.50		
W	15.70	16.30	

Mechanical Dimensions DFN8×8



SYMBOL	Millimeters		
STMBOL	Min.	Max.	
Α	0.800	0.900	
A1	-	0.050	
A3	0.195	0.211	
D	7.900	8.100	
Е	7.900	8.100	
е	2.00 BSC		
b	0.950	1.050	
D2	7.100	7.300	
E2	4.250	4.450	
L	0.400	0.600	
K	2.650	2.850	







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